

Aluminum	electrolytic	capacitors
		Capacitors

SMD capacitors

Series/Type: B41123

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B41123*		2013-02-22	2013-09-30	2014-03-31

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

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SMD capacitors B41123

Standard series - 105 °C

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General-purpose grade capacitors

Applications

■ General-purpose applications in the entertainment industry

Features

- Miniaturized dimensions
- RoHS compatible
- Load life of 1000 h at 105 °C

Construction

- Surface mounting device
- Minus pole marking on the case

Delivery mode

Taped and reeled Refer to chapter "SMD capacitors - Taping and packing" for further details.

Specifications and characteristics in brief

Rated voltage V _R	6.3 50 V D	C						
Operating temperature range		−55 °C +105 °C						
Rated capacitance C _R	0.1 1500 μ	F						
(20 °C, 120 Hz)								
Capacitance tolerance	±20% ≙ M							
Load life	1000 h	Requ	iremen	ts:				
(105 °C, V _R)		ΔC/C	≤ ±	20% of	f initial	value		
			(≤ 1	16 V: w	ithin ±	25% of	initial	value)
		tan δ	≤ 2	times	initial s	pecifie	d limit	
		I _{leak}	≤in	itial sp	ecified	limit		
Leakage current I _{leak} (20 °C, after 2 minutes)	$I_{leak} \le 0.01 \mu A \cdot \left(\frac{C_R}{\mu F}, \frac{V_R}{V}\right)$ or 3 μA , whichever is greater							
Low temperature stability	V _R (V DC)	6.3	10	16	25	35	50	
(impedance ratio) (120 Hz)	Z (-25 °C) Z (+20 °C)	4	3	2	2	2	2	
	Z (-40 °C) Z (+20 °C)	8	8	4	4	3	3	
Shelf life	After storage	for 100	00 h at	105 °C	the c	apacito	rs sha	I meet the
	requirement of load life test after reforming process. After test: V _R							
	to be applied for 30 minutes, 24 to 48 hours before measurement.							
Frequency multiplier	50 Hz	120 H	lz	300 H	lz	1 kHz		≥10 kHz
for rated ripple current	0.70	1.00		1.17		1.36		1.50





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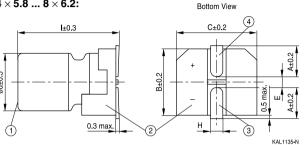


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Dimensional drawings

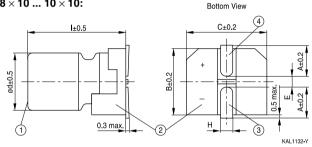
dxl(mm)

4 × 5.8 ... 8 × 6.2:



d x I (mm)

8 × 10 ... 10 × 10:



1	Case
2	Terminal base board
3	Minus pole
4	Plus pole

Case dimensions d × I (mm)	4 × 5.8	5 × 5.8	6.3 × 5.8	6.3×7.7	8 × 6.2	8 × 10	10 × 10
Α	1.8	2.1	2.4	2.4	3.3	2.9	3.2
В	4.3	5.3	6.6	6.6	8.3	8.3	10.3
С	4.3	5.3	6.6	6.6	8.3	8.3	10.3
E	1.0	1.3	2.2	2.2	2.3	3.1	4.5
L	5.8	5.8	5.8	7.7	6.2	10	10
Н	0.5 0.8				0.8 .	1.1	

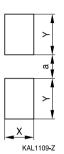




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Layout recommendation



$d \times I (mm)$	Х	Υ	а
4.0 × 5.8	1.6	2.6	1.0
5.0 × 5.8	1.6	3.0	1.4
6.3 × 5.8	1.6	3.5	2.1
6.3 × 7.7	1.6	3.5	2.1
8.0 × 6.2	2.5	4.0	2.1
8.0 × 10.0	2.5	3.5	3.0
10.0 × 10.0	2.5	4.0	4.0



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Overview of available types

V _R (V DC)	6.3	10	16	25	35	50
	Case dimens	sions d×I (mm	1)	l.	l.	
C _R (μF)						
0.10						4 × 5.8
0.22						4 × 5.8
0.33						4 × 5.8
0.47						4 × 5.8
1.0						4 × 5.8
2.2						4 × 5.8
3.3						4 × 5.8
4.7				4 × 5.8	4 × 5.8	5 × 5.8
10			4 × 5.8	5 × 5.8	5 × 5.8	6.3× 5.8
22	4 × 5.8	5 × 5.8	5 × 5.8	6.3× 5.8	6.3× 5.8	6.3 × 7.7 8 × 6.2
33	5 × 5.8	5 × 5.8	6.3× 5.8	6.3× 5.8	6.3 × 5.8 8 × 6.2	6.3× 7.7
47	5 × 5.8 6.3 × 5.8	6.3× 5.8	6.3 × 5.8	6.3 × 5.8 8 × 6.2	6.3× 5.8	6.3 × 7.7 8 × 10
100	6.3× 5.8	6.3× 5.8	6.3× 5.8	6.3× 7.7	6.3 × 7.7 8 × 10	8 ×10
150	6.3 × 5.8	6.3× 5.8	6.3 × 7.7	8 × 10	8 × 10	10 × 10
220	6.3 × 7.7 8 × 6.2	6.3× 7.7	6.3 × 7.7 8 × 10	8 ×10	10 × 10	10 × 10
330	6.3 × 7.7	8 × 10	8 × 10	10 × 10	10 × 10	
470	8 ×10	8 × 10	8 × 10	10 × 10		
680	8 ×10	10 × 10	10 × 10			
1000	10 × 10	10 × 10				
1500	10 ×10					

Other voltage and capacitance ratings are available upon request.





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Technical data and ordering codes

$\overline{V_R}$	C _R	Case dimensions	tan δ_{max}	I _{AC,R}	Ordering code
- K	120 Hz, 20 °C	d×I	120 Hz, 20 °C	120 Hz, 105 °C	
V DC		mm	,	mA	
6.3	22	4 × 5.8	0.30	22	B41123A2226M000
	33	5 × 5.8	0.30	31	B41123A2336M000
	47	5 × 5.8	0.30	37	B41123A2476M000
	47	6.3 × 5.8	0.30	42	B41123B2476M000
	100	6.3 × 5.8	0.30	62	B41123A2107M000
	150	6.3 × 5.8	0.30	86	B41123A2157M000
	220	6.3 × 7.7	0.30	96	B41123A2227M000
	220	8 × 6.2	0.30	102	B41123B2227M000
	330	6.3 × 7.7	0.30	105	B41123A2337M000
	470	8 × 10	0.30	210	B41123A2477M000
	680	8 × 10	0.30	210	B41123A2687M000
	1000	10 × 10	0.30	230	B41123A2108M000
	1500	10 × 10	0.30	310	B41123A2158M000
10	22	5 × 5.8	0.24	27	B41123A3226M000
	33	5 × 5.8	0.24	36	B41123A3336M000
	47	6.3 × 5.8	0.24	47	B41123A3476M000
	100	6.3 × 5.8	0.24	62	B41123A3107M000
	150	6.3 × 5.8	0.24	86	B41123A3157M000
	220	6.3 × 7.7	0.24	105	B41123A3227M000
	330	8 × 10	0.24	195	B41123A3337M000
	470	8 × 10	0.24	210	B41123A3477M000
	680	10 × 10	0.24	310	B41123A3687M000
	1000	10 × 10	0.24	310	B41123A3108M000
16	10	4 × 5.8	0.20	18	B41123A4106M000
	22	5 × 5.8	0.20	31	B41123A4226M000
	33	6.3 × 5.8	0.20	41	B41123A4336M000
	47	6.3 × 5.8	0.20	51	B41123A4476M000
	100	6.3 × 5.8	0.20	62	B41123A4107M000
	150	6.3 × 7.7	0.20	95	B41123A4157M000
	220	6.3 × 7.7	0.20	105	B41123A4227M000
	220	8 × 10	0.20	134	B41123B4227M000
	330	8 × 10	0.20	195	B41123A4337M000
	470	8 × 10	0.20	210	B41123A4477M000
	680	10 × 10	0.20	310	B41123A4687M000



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Technical data and ordering codes

$\overline{V_R}$	C _R	Case dimensions	tan δ _{max}	I _{AC.R}	Ordering code
- K	120 Hz, 20 °C	d×I	120 Hz, 20 °C	120 Hz, 105 °C	
V DC		mm	.202, 20 0	mA	
25	4.7	4 × 5.8	0.16	13	B41123A5475M000
20	10	5 × 5.8	0.16	23	B41123A5106M000
	22	6.3 × 5.8	0.16	39	B41123A5226M000
	33	6.3 × 5.8	0.16	49	B41123A5336M000
	47	6.3 × 5.8	0.16	56	B41123A5476M000
	47	8 × 6.2	0.16	66	B41123B5476M000
	100	6.3 × 7.7	0.16	91	B41123B5476W000
	150	8 × 10	0.16	140	B41123A5157M000
	220	8 × 10	0.16	155	B41123A5227M000
	330	10 × 10	0.16	190	B41123A5337M000
	470	10 × 10	0.16	300	B41123A5477M000
35	4.7	4 × 5.8	0.14	15	B41123A7475M000
	10	5 × 5.8	0.14	25	B41123A7106M000
	22	6.3 × 5.8	0.14	43	B41123A7226M000
	33	6.3 × 5.8	0.14	49	B41123A7336M000
	33	8 × 6.2	0.14	59	B41123B7336M000
	47	6.3 × 5.8	0.14	63	B41123A7476M000
	100	6.3 × 7.7	0.14	84	B41123A7107M000
	100	8 × 10	0.14	107	B41123B7107M000
	150	8 × 10	0.14	155	B41123A7157M000
	220	10 × 10	0.14	190	B41123A7227M000
	330	10 × 10	0.14	300	B41123A7337M000





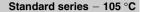
Standard series - 105 °C

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Technical data and ordering codes

1/	<u></u>	Case dimensions	tan δ _{max}	1	Ordering code
V_R	C _R			I _{AC,R}	Ordering code
	120 Hz, 20 °C	d×I	120 Hz, 20 °C	120 Hz, 105 °C	
V DC	μF	mm		mA	
50	0.1	4 × 5.8	0.14	1	B41123A6104M000
	0.22	4 × 5.8	0.14	2.6	B41123A6224M000
	0.33	4 × 5.8	0.14	3.2	B41123A6334M000
	0.47	4 × 5.8	0.14	3.8	B41123A6474M000
	1.0	4 × 5.8	0.14	6.3	B41123A6105M000
	2.2	4 × 5.8	0.14	11	B41123A6225M000
	3.3	4 × 5.8	0.14	14	B41123A6335M000
	4.7	5 × 5.8	0.14	19	B41123A6475M000
	10	6.3 × 5.8	0.14	31	B41123A6106M000
	22	6.3 × 7.7	0.14	48	B41123A6226M000
	22	8 × 6.2	0.14	51	B41123B6226M000
	33	6.3 × 7.7	0.14	60	B41123A6336M000
	47	6.3 × 7.7	0.14	63	B41123A6476M000
	47	8 × 10	0.14	81	B41123B6476M000
	100	8 × 10	0.14	140	B41123A6107M000
	150	10 × 10	0.14	180	B41123A6157M000
	220	10 × 10	0.14	220	B41123A6227M000







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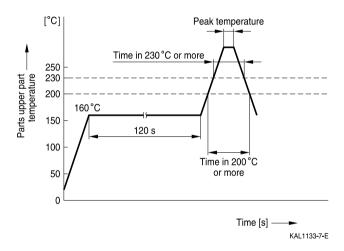
Mounting instructions

Soldering

Recommended conditions for series B41115, B41123 and B41145

For reflow, use thermal conduction systems such as infrared radiation (IR) or hot blast. Vapor heat transfer systems (VPS) are not recommended.

- Observe proper soldering conditions (temperature, time, etc.).
- Do not exceed the specified limits.
- Temperature measuring method: Measure temperature in assuming quantitative production, by sticking the thermo-couple to the capacitor upper part with epoxy adhesives.
- Consult us for additional reflow restrictions.



d (mm)	4 6.3	8 10
Peak temperature	260 °C (255 °C)	245 °C
Time in peak temperature	5 s in 250 °C or more (10 s in 250 °C or more)	10 s in 240 °C or more
Time in 230 °C or more	30 s	30 s
Time in 200 °C or more	70 s	70 s
Time of reflow	2 times	2 times



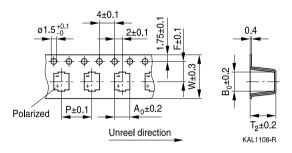


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Taping and packing

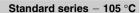
Taping of SMD capacitors



Case dimensions d × I (mm)	4 × 5.4	4 × 5.8	5 × 5.4	5 × 5.8	6.3 × 5.4
W	12.0	12.0	12.0	12.0	16.0
Р	8.0	8.0	12.0	12.0	12.0
F	5.5	5.5	5.5	5.5	7.5
A_0	5.0	5.0	6.0	6.0	7.0
B_0	5.0	5.0	6.0	6.0	7.0
T ₂	5.8	6.3	5.8	6.3	5.8

Case dimensions d × I (mm)	6.3 × 5.8	6.3×7.7	8×6.2	8 × 10	10 × 10
W	16.0	16.0	16.0	24.0	24.0
Р	12.0	12.0	12.0	16.0	16.0
F	7.5	7.5	7.5	11.5	11.5
A_0	7.0	7.0	8.7	8.7	10.7
B_0	7.0	7.0	8.7	8.7	10.7
T ₂	6.3	8.2	6.8	11.0	11.0

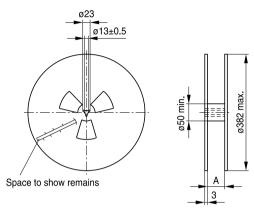






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Reel packing



KAL1110-3

Capacitor dimensions	Quantity per reel
$d \times I (mm)$	pcs.
4 × I	2000 pcs.
$5 \times I$, $6.3 \times I$, 8×6.2	1000 pcs.
8 × 10, 10 × I	500 pcs.

d×I (mm)	4 × I, 5 × I	$6.3 \times I, 8 \times 6.2$	8 × 10, 10 × I
A	14	18	26





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Cautions and warnings

General

- Aluminum electrolytic capacitors have a bi-polar structure. This is marked on the body of the capacitor. A capacitor must not be mounted with reversed polarity. The application of an AC or reverse voltage may cause a short circuit or damage the capacitor. Bi-polar capacitors must not be used in AC applications, where the polarity may be reversed in the circuits or is unknown.
- 2 The DC voltage applied to the capacitor terminal must not exceed its rated operating voltage, as this will result in a rapid increase of the leakage current and may damage the capacitor. It is recommended to operate the capacitor at 70 80% of its rated voltage to optimize its service life.
- 3 The ripple current applied to the capacitor must be within the permitted range. An excessive ripple current leads to impaired electrical properties and may damage the capacitor. Note that the sum of the peak values of the ripple voltage and the DC operating voltage must not exceed the rated DC voltage.
- 4 Capacitors must be used within their permitted range of operating temperature. Operation at room temperature optimizes their service life.
- 5 Capacitors with case diameter ≥8 mm are equipped with a safety vent. In capacitors fitted with a lead or soldering lug, the safety vent is usually located at the base of the case. It needs sufficient space around it to operate optimally. The following dimensions are recommended: for case diameter d = 8 to 16 mm, more than 2 mm; for d = 18 to 35 mm, more than 3 mm; and for d = 42 mm or more, more than 5 mm.
- 6 Capacitors should not be mounted with the safety vent face down on the board. Do not locate any wire or copper trace near the safety vent. Do not reverse the voltage, as this may result in excess pressure and the leakage of electrolyte.
- 7 Gas is released through the safety vent when the pressure inside the capacitor is too high. A gaseous liquid around the safety vent does not indicate a leakage of electrolyte.
- 8 The capacitor should be stored under conditions of normal temperature and in a non-acid, non-alkali environment of normal humidity. Exposure to high temperatures, for example under direct sunlight, will reduce its operating life. If the capacitor is stored in an environment containing acids or alkalis, the solderability of the leads may be affected.
- 9 containing acids or alkalis, the solderability of the leads may be affected. The leakage current of an aluminum electrolytic capacitor may increase after a long period of storage. After such storage, the capacitor must be aged by applying the rated operating voltage for 6 – 8 hours before use.
- 10 Manual soldering:
 - a Soldering must be performed within the specified conditions.

 Bit temperature: 350 °C; application time of soldering iron: 3 seconds.
 - b Ensure that the soldering iron does not touch any part of the capacitor body.



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- 11 Do not apply excessive force to the leads and terminals. Do not move the capacitor after soldering it onto the PC board and do not carry the PC board by gripping the capacitor. Observe the following rules to prevent undue stress to the capacitor:
 - a Do not tilt or bend the capacitor after soldering.
 - b Ensure that the terminal spacing matches the corresponding hole spacing on the PC board.
- 12 The aluminum case is not insulated from the cathode. Do not place a conductor under the aluminum capacitors on the PC board as this may cause a short circuit. The case and top of capacitors used in switched mode power supplies have a high-voltage-resistant heat shrink sleeve to ensure safe usage.
- 13 The leads of capacitors with a case diameter exceeding 14 mm cannot be used for fixing.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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